

Low Noise Tunable Laser

PPCL700 - Datasheet

The **Pure Photonics** full-band tunable laser solution provides a very narrow linewidth (~15 kHz), significantly reduced low-frequency AM and FM noise and a range of operating modes in this low-noise setting. The product can access any desired frequency set-point in either the C-

band or L-band. Output power can be set as low as 7dBm and as high as 17dBm (optional).

The PPCL700 sensor-grade tunable laser is based on the Neophotonics telecom-grade tunable laser (our PPCL600), using the optical engine along with a modified and optimized electronics platform, providing better noise performance and additional control features (such as sweeps, jumps, Amplitude Modulation and Frequency Modulation).

Snapshot

Full C-Band Tunable
Power up to 17dBm (50mW)
15kHz narrow linewidth
Reduced AM/FM low freq. noise
Advanced operation modes

The laser and its features are designed for high SNR (Signal-to-Noise-Ratio) applications, such as sensing and T&M (Test and Measurement).

In its low-noise mode, the laser disables its control loops and is essentially frozen. To enable tunability and flexibility, **Pure Photonics** is developing optimized control schemes for this operating mode, enabling:

- Clean Sweep: a (repeating) frequency sweep of 50GHz up to 250GHz
- Frequency Modulation: BW of 100kHz and amplitude of up to 100MHz
- Amplitude Modulation: BW of 1MHz
- Clean Jump: jump to any frequency within 2 seconds
- Clean Scan: scan the full frequency range as fast as within 10 seconds
- Clean Measurement: integrated DAQ functionality with the other functions
- Low RIN: reduced noise with a 200kHz low-pass filter (not compatible with AM)

Updates to the firmware and the GUI will be regularly available on the **Pure Photonics** website (www.pure-photonics.com) and if possible are backwards compatible.

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2. Operating Principle

The PPCL700 is the highest performance micro-ITLA on-the-market (MSA based, see https://www.oiforum.com/wp-content/uploads/2019/01/OIF-Micro-ITLA-01.1.pdf and https://www.oiforum.com/wp-content/uploads/2019/01/OIF-ITLA-MSA-01.3.pdf). The product is controlled through a digital interface. The user can operate the product without having to control or understand the underlying technology.

It has an External Cavity Laser design (see figure), with tunable filters embedded in the cavity for frequency control. The Cavity consists out of an InP back-facet coated gain chip with front-facet AR coating and a high-reflection end-mirror, mounted on a PZT element. By changing the injection current into the gain-chip, the product accurately controls the operating power to the user-defined power target.

Within the cavity two Silicon etalon filters, with slightly different Free Spectral Range (FSR), utilize the Vernier effect to select one dominant cavity mode. The frequency is controlled through micro-temperature sensing and heating elements on the filters. The dominant cavity mode is aligned with the etalon transmission peaks through adjustment of the cavity temperature.

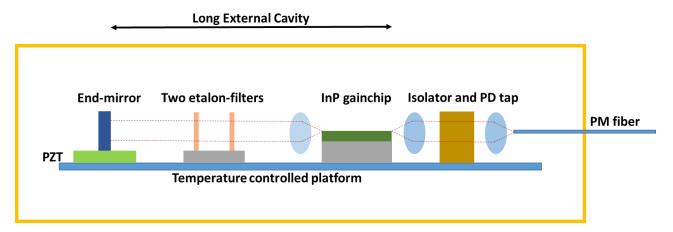


Figure 1: illustration of optics engine



3. Specifications

Absolute Maximum Ratings

In Table 1 the absolute maximum ratings for the product are listed. These settings are never to be exceeded and may result in critical damage to the product if applied.

Parameter	Unit	Min	Max
Operating temperature	°C	-5	75
Storage temperature	°C	-40	85
Humidity	%DH	5	85
Voltage +3.3V	V	0	3.6
Voltage -5.2V	V	-5.5	0.3
Fiber bend radius	Mm	20	
Current Source Slew rate	V/msec		20
Mounting surface flatness	micron		25
Installation torque	Inch-lb	0.9	1.1

Table 1: Absolute maximum ratings

Performance Specifications

In Table 2 the more general performance specifications of the product are listed

Parameter	Unit	Min	Тур	Max
Operating Temperature	°C	0		70
Power				
Max set-power (generic version)	dBm	7		13.5
Optional up to (*1)		7		17
Power accuracy	dB	-1		+1
Power resolution	dB			0.01
Short term power variation	dB	-0.05		0.05
Frequency				
Frequency range (generic version)	THz	191.5		196.25
Optional up to 60nm within		189.7		197.25
Wavelength range (generic version)	nm	1527.6		1565.5
Optional up to 60nm within		1515		1580
Frequency accuracy	GHz	-1.5		1.5
Frequency resolution (set-point)	GHz			0.1
Fine Tune Frequency Range	GHz	-30		30
Fine Tune Frequency resolution	GHz			0.001
Optical characteristics				
SMSR	dB	40	55	
OSNR	dB	40	60	
Intrinsic linewidth	kHz		15	20
FM noise spectrum (standard mode)	Тур.		TBD	
FM noise spectrum (low noise mode)	Тур.		TBD	
AM noise (RIN) 7dBm	dB/Hz			-140
13dBm				-145

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Back-reflection	dB			-14
Polarization Extinction Ratio	dB	18		
Timing characteristics				
Warm-start time	sec			30
Cold-start time	sec			60
Electrical characteristics				
Supply voltage +3.3V	V	3.15	3.3	3.45
Supply current +3.3V	mA		400	1200
Supply voltage -5.2V	V	-5.45	-5.2	-4.95
Supply current -5.2V	mA		100	1500

Table 2: performance specifications

Digital Interface Specifications

The digital interface to the product is compliant to the micro-ITLA MSA. Most functions of this MSA are supported.

Clean Sweep Specifications

Every unit has a 50GHz Clean Sweep enabled. A wider sweep range can optionally be configured.

In Table 3 the performance targets for the clean sweep feature are listed.

Parameter	Unit	Min	Тур	Max
Modehop free range	GHz			50
Modehop free range				250
(under development)				
Power stability	dB	-1		1
Typical cycle time	s/GHz			0.1
Slew rate (of one slope)	GHz/s	1	20	40

Table 3: clean sweep specifications

Frequency Modulation Specifications

This feature is **optional** and requires an additional hardware interface.

In Table 4 the performance targets for the clean modulation feature are listed.

Parameter	Unit	Min	Тур	Max
Modehop free range internal drive	MHz			80
Cut-off frequency	kHz			100
Applied voltage (DC coupled)	V	0		6

Table 4: frequency modulation specifications

Amplitude Modulation Specifications

This feature is **optional** and requires an additional hardware interface.

In Table 4 the performance targets for the clean modulation feature are listed.

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Parameter	Unit	Min	Typ	Max



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Cut-off frequency	kHz		1,000
Applied voltage (DC coupled)	V	-10	10

Table 5: amplitude modulation specifications

Clean Jump Specifications

In Table 6 the performance targets for the clean jump feature are listed.

Parameter	Unit	Min	Тур	Max
Time to correct optical mode	sec			1
Power error to target	dB	-3	-0.5	0.5
Frequency error to target	GHz	-3	0	3
Time to specification	sec			2
Power error to target	dB	-0.5	0	0.25
Frequency error to target	GHz	-0.5	0	0.5

Table 6: clean jump specifications

Clean Scan Specifications

In Table 7 the performance targets for the clean scan feature are listed.

Parameter	Unit	Min	Тур	Max
Minimum scan time	GHz/s	20		
Power error from average	dB	-0.5	0	0.5
Frequency error from linear scan	GHz	-5		5

Table 7: clean scan specifications

Clean Measurement Specifications

In Table 8 the performance targets for the clean measurement feature are listed.

Parameter	Unit	Min	Тур	Max
Measurement DAQ #bits	-	12		
Input voltage	V	0		8
Sample-rate	Hz	100		
#points	-	1000		

Table 8: clean scan specifications



4. Technical Drawing

Parameter	Unit	Min	Тур	Max
Fibertype		Polarization	on Maintainin	g, PANDA
Fiberlength (from edge of board)	cm	50		
Width (W)	mm		20	
Length (L)	mm		45	
Height (H) supersedes MSA	mm			10
Input connector		20 pin Samtec male (FTHM)		

Table 9: dimensional information

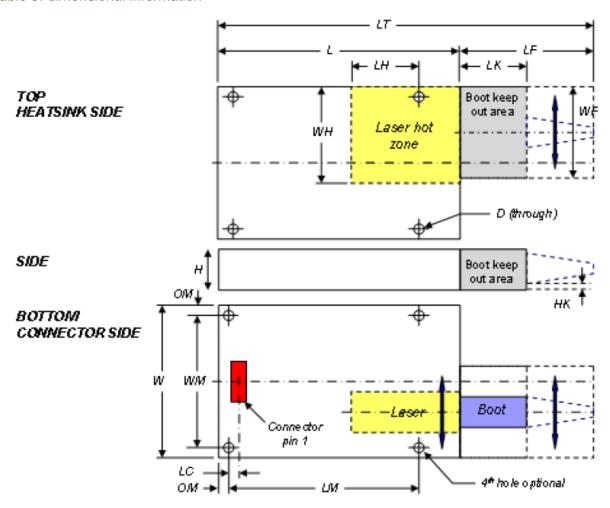


Figure 2: mechanical configuration

Parameter	Symbol	Value
Width of module	W	20 mm
Length of module	L	MIN 34 mm MAX 45 mm
Total length	LT	MAX 65 mm
Height of module	Н	MAX 7.5 mm
Pitch of mounting hole – length direction	LM	30 mm
Pitch of mounting hole – width direction	WM	16 mm
Offset of mounting hole from edge of module	OM	2 mm
Diameter mounting hole	D	2 mm
Offset centerline connector to mounting hole	LC	2 mm
Width fiber boot area	WF	14 mm
Length fiber boot area	LF	MAX 25 mm
Length fiber boot keep out zone	LK	10 mm
Clearance below boot	HK	1 mm
Length between start of laser hot zone and mounting hole	LH	12 mm
Width of laser hot zone	WH	14 mm

Figure 3: Parameters



5. Compliance

The following information is obtained from the optics vendor.

Electromagnetic compatibility

Requirement	Regulation	Performance Level		
Electromagnetic interference (EMI)	FCC rules, Part 15, subpart B EN 55022	Meets Class B limits with a minimum 6 dB margin		
Electrostatic discharge (ESD)	JEDEC JESD22-A114-B Human Body Model	± 500 kV contact discharge to connector electrical pins with no degradation in performance or loss of function		
	EN 61000-4-2	±15 kV air discharge ± 8 kV contact discharge to face plate Meets Level B test criteria (that is, no degradation of performance or loss of function occurs)		
Radio frequency electromagnetic field (Radiated immunity)	EN 61000-4-3, level A test criteria	3 V/m from 80 MHz to 1G Hz with no degradation of performance or loss of function		

Safety compliance

Requirement	Regulation	Title		
Product Safety	UL 60950-1 CSA C22.2 No. 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (USA and Canada)		
	EN 60950-1+A11	Information Technology Equipment – Safety - Part 1: General Requirements (European Union)		
	IEC 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (International)		
	GR-63-CORE Section 4.2, Clause 4.2.3.1	Compliant with the fire resistance requirements of Telcordia Technologies Generic Requirements GR-63-CORE document for discrete electronic components.		
Laser Safety	21CFR1040.10	Code of Federal Regulations Title 21 Chapter I Subchapter J – Radiological Health Part 1040: Performance Standards for Light-Emitting Products		
	EN 60825-1+A1 +A2	Safety of Laser Products - Part 1: Equipment Classification, Requirements and User's Guide		
	IEC 60825-1+A1 +A2	Safety of Laser Products - Part 1: Equipment Classification, Requirements and User's Guide		
	EN 60825-2	Safety of Laser Products - Part 2: Safety of Optical Fiber Communication Systems		
	IEC 60825-2	Safety of Laser Products - Part 2: Safety of Optical Fiber Communication Systems		

The PPCL700 complies with 21 CFR 1040.10 except for deviations pursuant to Laser Notice No. 50 dated June 24, 2007.

This product is a component laser device and as such, does not include all end product safety controls or design features as required by international laser safety standard, IEC 60825-1, or by the U.S. Food and Drug Administration (FDA), Center for Devices and Radiological Health (CDRH), regulation CFR 1040.10.

This device is a class 1M laser product for use only under the recommended operating conditions and ratings specified in this document. Use of controls or adjustments or performance of procedures other than these specified in this product datasheet may result in hazardous radiation exposure.

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Invisible laser radiation – Do not view the laser output from this device directly with optical instruments (e.g., eye loupes, magnifiers, microscopes). Viewing the laser output with certain optical instruments within a distance of 100mm may pose an eye hazard. Class 1M laser product.

Invisible Laser Radiation
Do not view directly
with optical instruments.
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European Union RoHS Compliance

This product complies with the European Union directive for Restrictions of Hazardous Substances (RoHS) – Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment, Directive 2002/95/EC plus all amendments.

This product does contain lead in solder and components, but utilizes the applicable exemptions (7b, 7(c)i, 13a).

Product certification and compliance marking

Hazardous Substance Statement (China RoHS)

	有毒有害物质或元素 (Hazardous Substance)					
部件名称 (Parts)	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
集成光电器件 Integrated optical circuit board assembly	×	0	0	0	0	0
金属盒件 Metal enclosure	0	0	0	0	0	0

- 表示该有毒有害物质在该部件所有均质材料中的含量均在SJ/T 11363-2006标准规定的限量要求以下。
- Indicates that this hazardous substance contained in all homogeneous materials of this part is below the limit requirement in SJ/T 11363-2006.
- × :表示该有毒有害物质至少在该部件的某一均质材料中的含量超出SJ/T 11363-2006标准规定的限量要求。
- Indicates that this hazardous substance contained in at least one of the homogeneous materials of this
 part is above the limit requirement in SJ/T 11363-2006.

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The Environment-Friendly Use Period (EFUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked. The Environment-Friendly Use Period is valid only when the product is operated under the conditions defined in the product manual.

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6. Ordering and Technical Support

Please contact the **Pure Photonics** team for further information and support, as well as quotations.

This datasheet refers as a reference to the product capabilities and features. The exact performance and the features included are listed on the quote and purchase order.

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